

Customer No.: 31561  
Application No.: 10/605,215  
Docket No.: 10039-US-PA

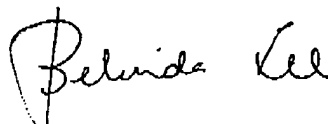
REMARKS

Applicant would like to elect Group I, claims 1-9 and 15-22, drawn to a semiconductor device classified in class 257, subclass 778. Please cancel GroupII, claims 10-14, drawn to a method of fabricating a semiconductor device, classified in class 438, subclass 10+ without waiver, prejudice or disclaimer.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Respectfully submitted,

Date: Dec. 28, 2004



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